

## C0805H101FCGACTU

**Specifications** 

Insulation Resistance

Aliases (C0805H101FCGAC7800) SMD Indust COG HVHT200C, Ceramic, 100 pF, 1%, 500 VDC, COG, SMD, MLCC, High Temperature, Ultra-Stable, Low Loss, 0805, 0.7 mm



General Information	
Series	SMD Indust COG HVHT200C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable, Low Loss
Features	High Temp, Ultra-Stable, Low Loss
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	14 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
Т	1.25mm +/-0.15mm
S	0.7mm MIN
В	0.5mm +/-0.25mm

Capacitance 100	) pF
Measurement Condition 1 MI	Hz 1.0Vrms
Tolerance 1%	
Voltage DC 500	O VDC
Dielectric Withstanding Voltage 750	VDC
Temperature Range -55	/+200°C
Temp. Coefficient CO	G
Capacitance Change with 30 Reference to +25°C and 0 VDC Applied (TCC)	ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor 0.1%	%1MHz1.0Vrms
Aging Rate 0%	Loss/Decade Hour

100 GOhms

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500

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